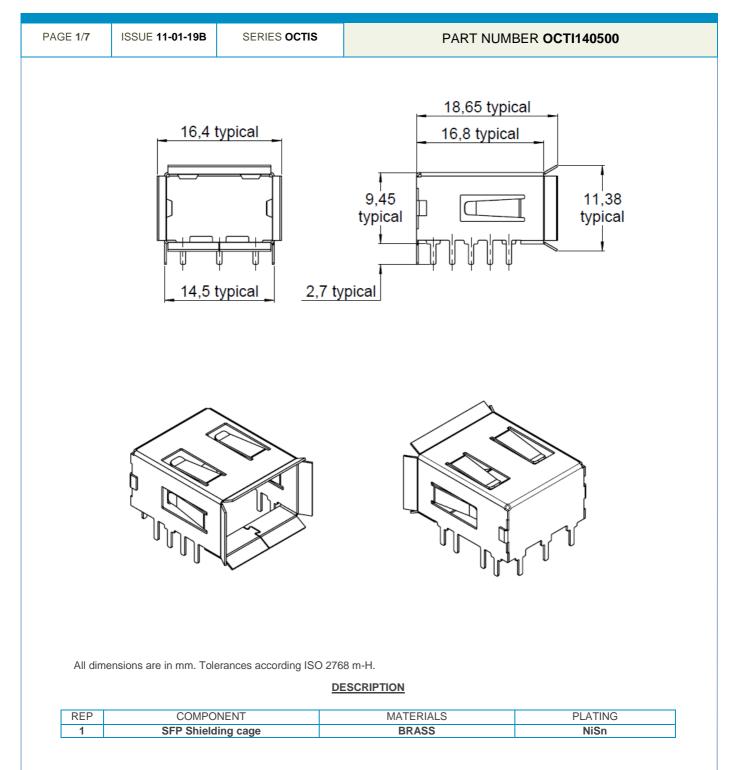


OCTIS RIGHT ANGLE SFP CAGE PIN IN PASTE BY TRAY



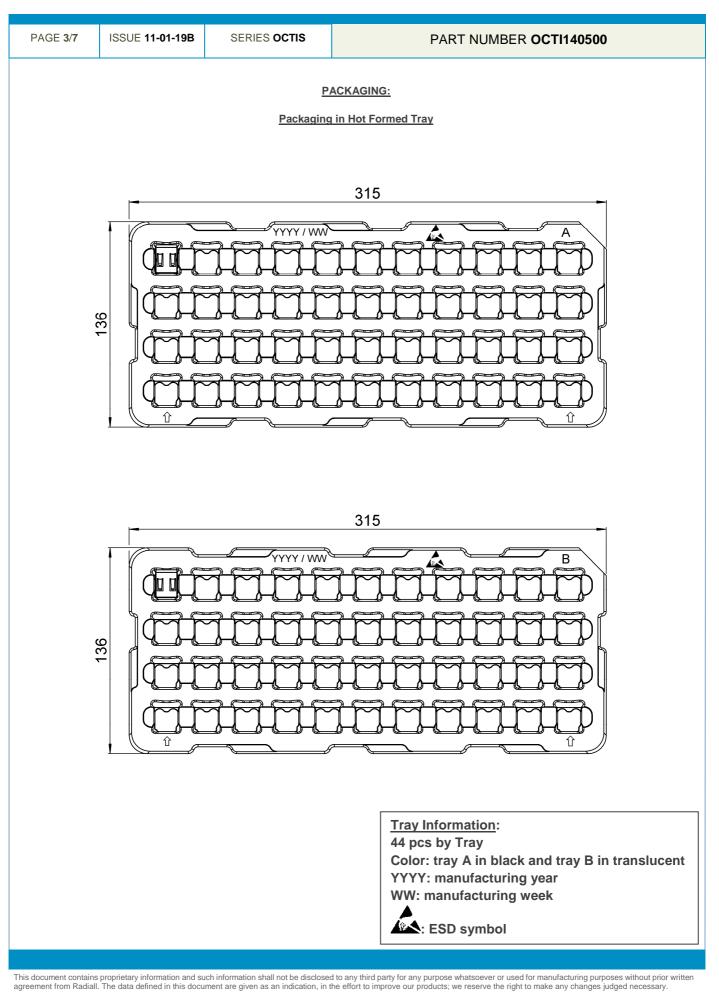


OCTIS RIGHT ANGLE SFP CAGE PIN IN PASTE BY TRAY

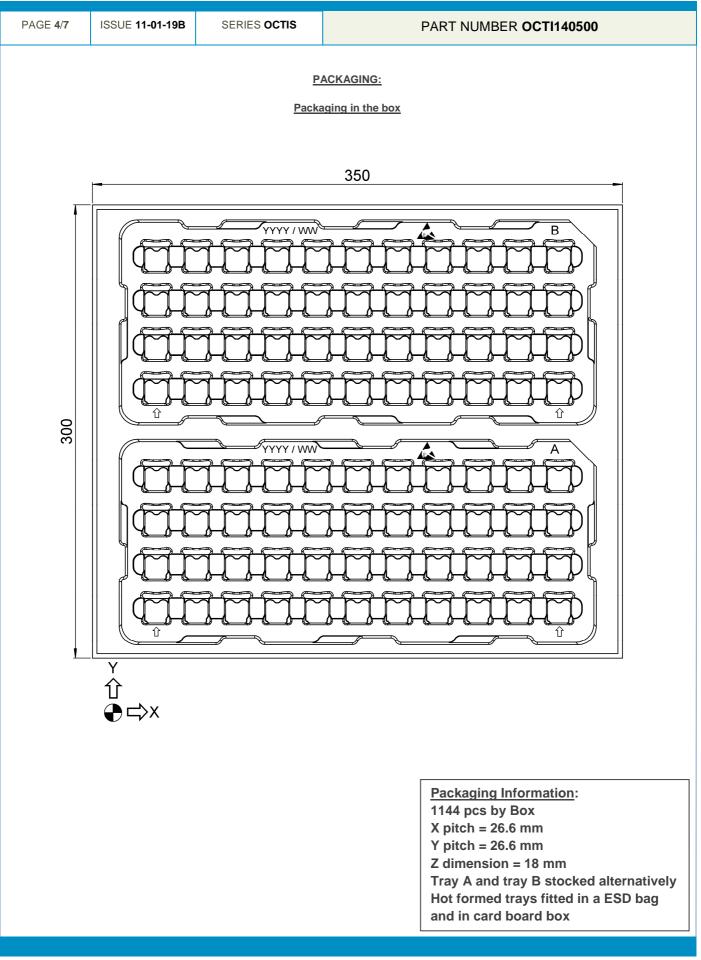
PAGE <b>2/7</b>	ISSUE 11-01-19B	SERIES OCTIS	PART NUMBER OCTI140500			
GENERAL CHARACTERISTICS						
<b>Mechanical</b> Mating endurance (cycles) Vibration Weight (g)		IEC 61300-2-2 IEC 61300-2-1 -	100 - 1,6530			
Environmental Operating temperature (°C) Storage temperature (°C) RoHS		IEC 61300-2-22 IEC 61300-2-22 -	-40 / +85 -65 / +85 Compliant			
Others - Handling		-	ESD approved Only with gloves			



OCTIS RIGHT ANGLE SFP CAGE PIN IN PASTE BY TRAY



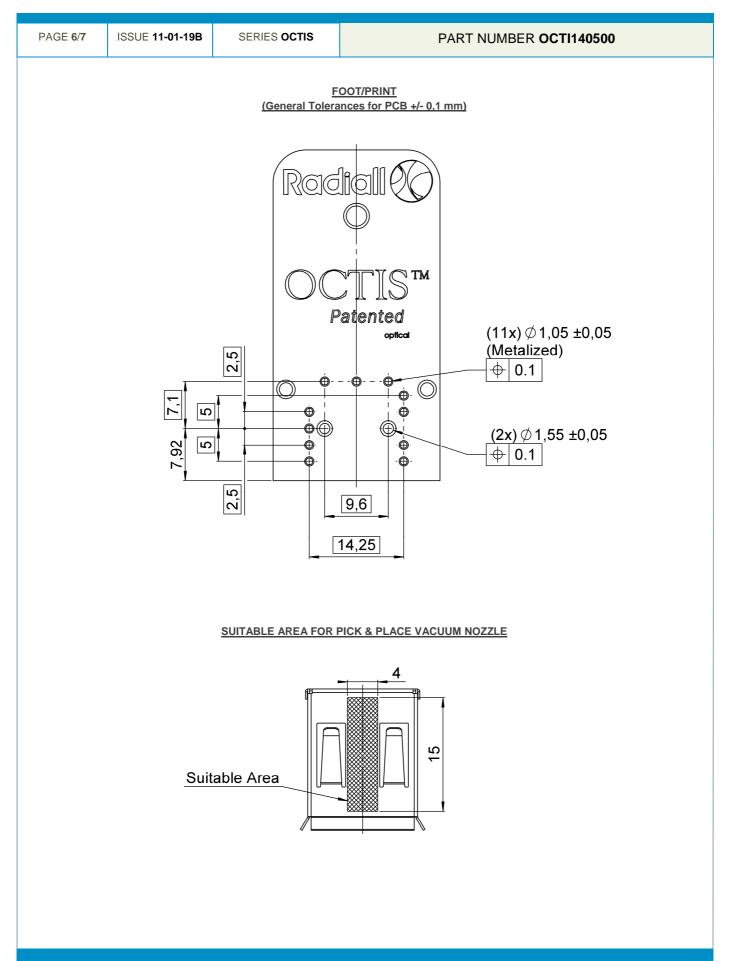
OCTIS RIGHT ANGLE SFP CAGE PIN IN PASTE BY TRAY



**Technical Data Sheet** OCTIS RIGHT ANGLE SFP CAGE PIN IN PASTE BY TRAY PAGE 5/7 ISSUE 11-01-19B SERIES OCTIS PART NUMBER OCTI140500 **POSITIONNING AND PATTERN DEFINITION** OCTIS SFP Version with universal receptacle  $5,72 \pm 0,40$ (3,5) 32,58 ±0,30 **MECT** locating holes  $\emptyset$ 1,55 ±0,05 32,58 ±0,30 0 tented Reference  $\bigcirc$ point MECT connector for illustration > ±0,6 Centering of the shielding cage vs receptacle cavity For use with OCTIS Plug Kit p/n OCTI.117.500



OCTIS RIGHT ANGLE SFP CAGE PIN IN PASTE BY TRAY





OCTIS RIGHT ANGLE SFP CAGE PIN IN PASTE BY TRAY

|--|

ISSUE 11-01-19B

SERIES OCTIS

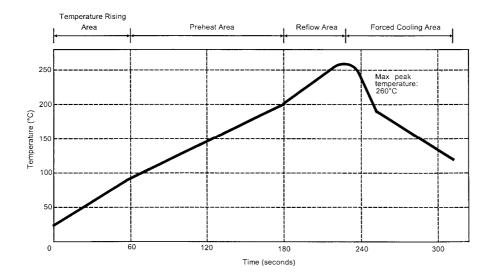
PART NUMBER OCTI140500

## SOLDER PROCEDURE\*

- 1. Deposit solder paste (Sn Ag4 Cu0.5) on solder pads / mounting area by screen printing application. We recommend a low residue flux. Verify that the edges of the pads are clean.
- 2. Place the component on the mounting area with a pick & place machine. A video camera is recommended for a good positioning of the component. Adhesive agents must not be used on the component.
- 3. This process of soldering has been tested with a convection oven. Below please find the typical soldering profile to use.
- 4. Optional cleaning of printed circuit board.
- 5. Check solder joints and position of the component by visual inspection.

Note: When soldering a receptacle, no plug should be mated to the receptacle before completion of this procedure.

#### **TEMPERATURE PROFILE**



Parameter	Value	Unit
Temperature rising Area	1 to 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to - 4	°C/sec
Max dwell time above 100°C	420	sec

\*Typical data for reflow process. Alternatively, wave soldering is also possible

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